

#### High Voltage Hex Inverter Buffer / Driver Logic IC in bare die form

Rev 1.0 29/07/20

#### Description

The 7406 comprises x6 inverter buffer/drivers with high voltage open-collector outputs. The device finds use as high-level circuit interface or for driving high-current loads and is also characterised to drive TTL inputs as inverted buffer. The device has a 30V minimum breakdown voltage and 40mA maximum sink current.

## **Ordering Information**

The following part suffixes apply:

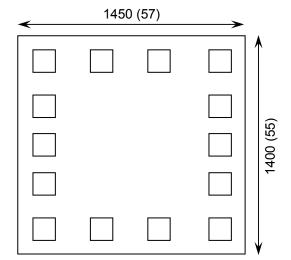
No suffix - MIL-STD-883 /2010B Visual Inspection

For High Reliability versions of this product please see  $\frac{5406}{}$ 

#### Features:

- High Sink-Current Capability: 40mA
- High Voltage Open-Collector Driver
- Minimum breakdown voltage: 30V
- Input Clamp Diodes minimize transmission-line effects
- TTL compatible inputs
- Direct drop-in replacement for obsolete components in long term programs.

### Die Dimensions in µm (mils)



### **Supply Formats:**

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape On request
- Unsawn Wafer On request
- Die Thickness <> 350µm(14 Mils) On request
- Assembled into Ceramic Package On request

#### **Mechanical Specification**

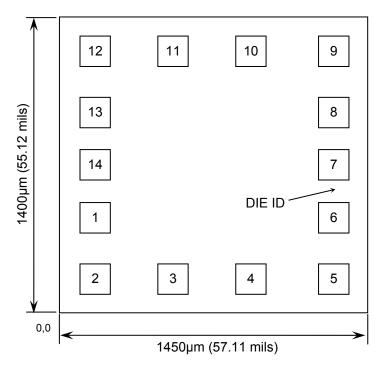
Die Size (Unsawn)	1450 x 1400 57 x 55	μm mils	
Minimum Bond Pad Size	140 x 140 5.5 x 5.5	μm mils	
Die Thickness	350 (±20) 13.78 (±0.79)	μm mils	
Top Metal Composition	Al 1%Si 1.1μm		
Back Metal Composition	N/A – Bare Si		





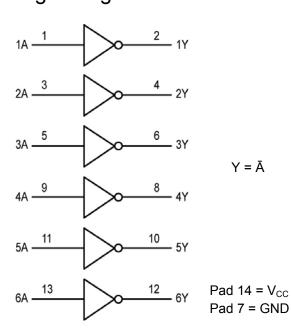
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## Pad Layout and Functions



PAD	FUNCTION	COORDINATES (mm)			
IAD	TONOTION	X	Υ		
1	1A	0.090	0.380		
2	1Y	0.090	0.090		
3	2A	0.460	0.090		
4	2Y	0.830	0.090		
5	3A	1.220	0.090		
6	3Y	1.220	0.380		
7	GND	1.220	0.630		
8	4Y	1.220	0.880		
9	4A	1.220	1.170		
10	5Y	0.830	1.170		
11	5A	0.460	1.170		
12	6Y	0.090	1.170		
13	6A	0.090	0.880		
14	V <sub>CC</sub>	0.090	0.630		
CONNECT CHIP BACK TO GND OR FLOAT					

## Logic Diagram



### Truth Table

INPUTS OUTPUT					
Α	Υ				
L Z					
Н	L				
H = High level (steady state)					
L = Low level (steady state)					
Z = High Impedance					





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# Absolute Maximum Ratings<sup>1</sup>

PARAMETER	SYMBOL	VALUE	UNIT
DC Supply Voltage	V <sub>CC</sub>	7.0	V
DC Input Voltage	V <sub>IN</sub>	5.5	V
DC Output Voltage	V <sub>OUT</sub>	30	
Storage Temperature Range	T <sub>STG</sub>	-65 to 150	°C

<sup>1.</sup> Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

### **Recommended Operating Conditions**

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PARAMETER	SYMBOL	MIN	MAX	UNITS
Supply Voltage	$V_{CC}$	4.75	5.25	V
High-Level Input Voltage	V <sub>IH</sub>	2	-	V
Low-Level Input Voltage	V <sub>IL</sub>	-	0.8	V
High-Level Output Voltage	$V_{OH}$	-	30	V
Low-Level Output Current	I <sub>OL</sub>	-	40	mA
Operating Temperature Range	T <sub>J</sub>	-40	+85	°C

# DC Electrical Characteristics<sup>2</sup> T<sub>J</sub> = -40°C to 85°C unless otherwise specified

PARAMETER	SYMBOL CONDITIONS	LIMITS			UNITS	
		MIN	TYP	MAX	UNITS	
Input Clamp Voltage	V <sub>IK</sub>	V <sub>CC</sub> = 4.25V, I <sub>IN</sub> = -12mA	-	-	-1.5	V
High-Level Output Current	I <sub>OH</sub>	$V_{CC} = 4.25V,$ $V_{IL} = 0.8V, V_{OH} = 30V$	-	-	0.25	mA
Low-Level Output Voltage	Va	$V_{CC} = 4.25V$ , $V_{IH} = 2V$ , $I_{OL} = 16mA$	-	-	0.4	V
	VOL	$V_{CC} = 4.25V,$ $V_{IH} = 2V, I_{OL} = 40mA$	-	-	0.7	
Input Current	I <sub>IN</sub>	$V_{CC} = 5.25V, V_{IN} = 5.25V$	-	-	1	mA
High-Level Input Current	I <sub>IH</sub>	V <sub>CC</sub> = 5.25V, V <sub>IH</sub> = 2.4V	-	-	0.04	mA
Low-Level Input Current	I <sub>IL</sub>	$V_{CC} = 5.25V, V_{IL} = 0.4V$	-	-	-1.6	mA
Supply Current	L	V <sub>CC</sub> = 5.25 ,Output High	-	-	48	mA
	$V_{CC} = 5.25$ , Output Low	-	-	51		





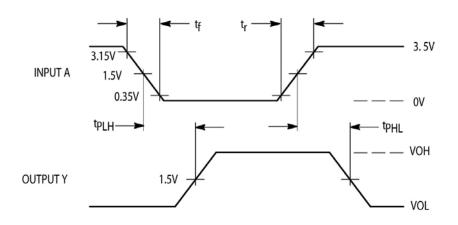
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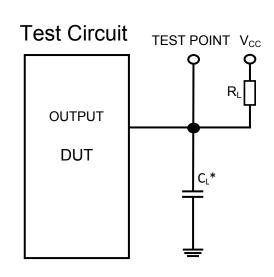
## AC Electrical Characteristics<sup>2</sup>

PARAMETER	PARAMETER SYMBOL CONDITIONS	CONDITIONS	TIONS			UNITS
T / W WILL I LIX		GGREFITIONS	MIN	TYP	MAX	Oiti10
Turn-Off Delay, Input to Output	t <sub>PLH</sub>	$T_A = 25^{\circ}C$ , $V_{CC} = 5V$ , $R_L = 110\Omega$ , $C_L = 15pF$ , Input $t_r = t_f = 10ns$	-	-	18	
Turn-On Delay, Input to Output	t <sub>PHL</sub>		-	-	28	ns

<sup>2.</sup> Not production tested in die form, characterized by chip design

## **Switching Waveform**





\* Includes all probe and jig capacitance

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